N-Channel Depletion-Mode Vertical DMOS FETs

Ordering Information

BV_{DSX} / BV_{DGX}	$R_{DS(ON)}$ (max)	I_{DSS} (min)	Order Number / Package		
			TO-92	TO-243AA*	Die
450V	20Ω	200mA	DN3545N3	DN3545N8	DN3545ND

* Same as SOT-89. Product shipped on 2000 piece carrier tape reels.

Features

- ☐ High input impedance
- ☐ Low input capacitance
- ☐ Fast switching speeds
- ☐ Low on resistance
- ☐ Free from secondary breakdown
- ☐ Low input and output leakage

Applications

- ☐ Normally-on switches
- ☐ Solid state relays
- ☐ Converters
- ☐ Constant current sources
- ☐ Power supply circuits
- ☐ Telecom

Advanced DMOS Technology

These depletion-mode (normally-on) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

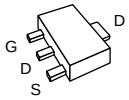
Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Absolute Maximum Ratings

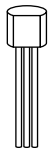
Drain-to-Source Voltage	BV_{DSX}
Drain-to-Gate Voltage	BV_{DGX}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

* Distance of 1.6 mm from case for 10 seconds.

Package Options



TO-243AA
(SOT-89)



TO-92

Note: See Package Outline section for dimensions.

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Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ T_A = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}*	I_{DRM}
TO-92	136mA	1.6A	0.74W	125	170	136mA	1.6A
TO-243AA	200mA	300mA	1.6†	15	78†	200mA	300mA

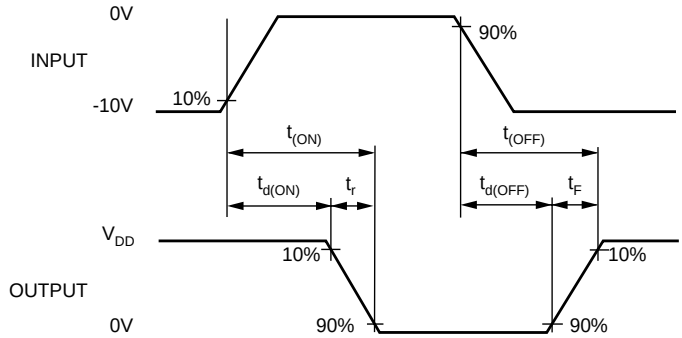
* I_D (continuous) is limited by max rated T_j.
† Mounted on FR4 board, 25mm x 25mm x 1.57mm. Significant P_D increase possible on ceramic substrate.

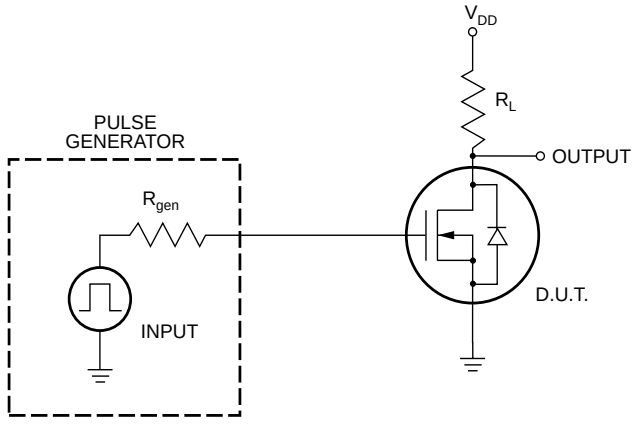
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSX}	Drain-to-Source Breakdown Voltage	450			V	V_{GS} = -5V, I_D = 100µA
$V_{GS(OFF)}$	Gate-to-Source OFF Voltage	–1.5		–3.5	V	V_{DS} = 25V, I_D= 10µA
$\Delta V_{GS(OFF)}$	Change in $V_{GS(OFF)}$ with Temperature			4.5	mV/°C	V_{DS} = 25V, I_D= 10µA
I_{GSS}	Gate Body Leakage Current			100	nA	V_{GS} = ± 20V, V_{DS} = 0V
$I_{D(OFF)}$	Drain-to-Source Leakage Current			1.0	µA	V_{GS} = -5V, V_{DS} = Max Rating
				1.0	mA	V_{GS} = -5V, V_{DS} = 0.8 Max Rating T_A = 125°C
I_{DSS}	Saturated Drain-to-Source Current	200			mA	V_{GS} = 0V, V_{DS} = 15V
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance			20	Ω	V_{GS} = 0V, I_D = 150mA
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature			1.1	%/°C	V_{GS} = 0V, I_D = 150mA
G_{FS}	Forward Transconductance	150			m℧	I_D = 100mA, V_{DS} = 10V
C_{ISS}	Input Capacitance			360	pF	V_{GS} = -5V, V_{DS} = 25V f = 1 MHz
C_{OSS}	Common Source Output Capacitance			40		
C_{RSS}	Reverse Transfer Capacitance			15		
$t_{d(ON)}$	Turn-ON Delay Time			20	ns	V_{DD} = 25V, I_D = 150mA, R_{GEN} = 25Ω, V_{GS} = 0V to -10V
t_r	Rise Time			30		
$t_{d(OFF)}$	Turn-OFF Delay Time			30		
t_f	Fall Time			40		
V_{SD}	Diode Forward Voltage Drop			1.8	V	V_{GS} = -5V, I_{SD} = 150mA
t_{rr}	Reverse Recovery Time		800		ns	V_{GS} = -5V, I_{SD} = 150mA

Notes:
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit





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